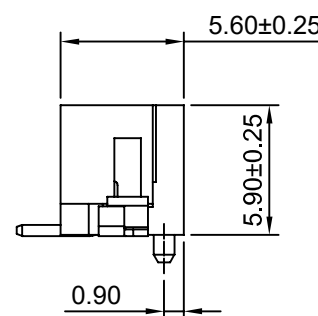
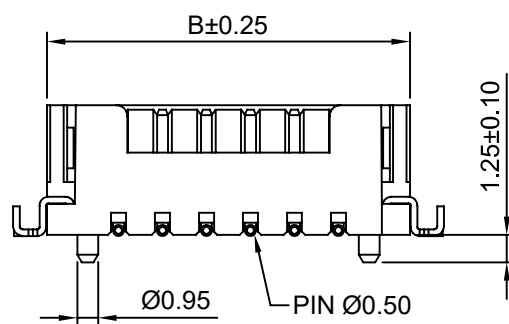
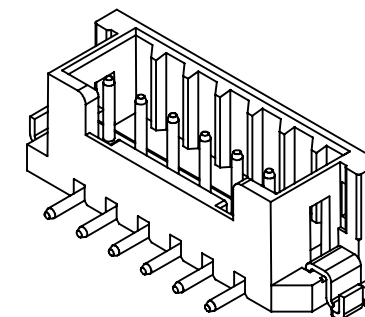
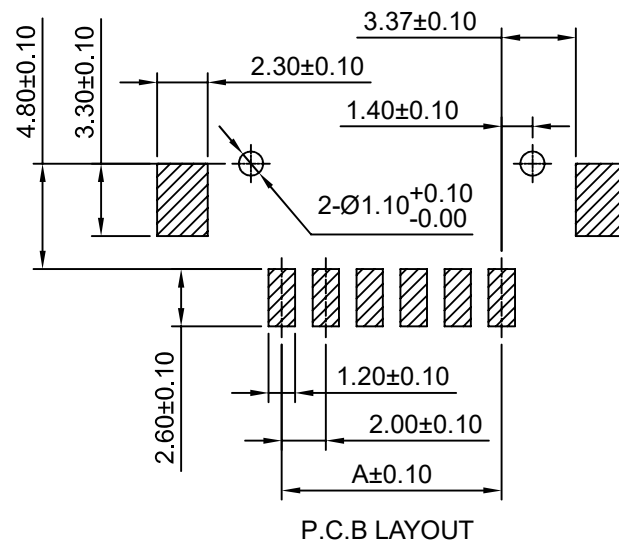
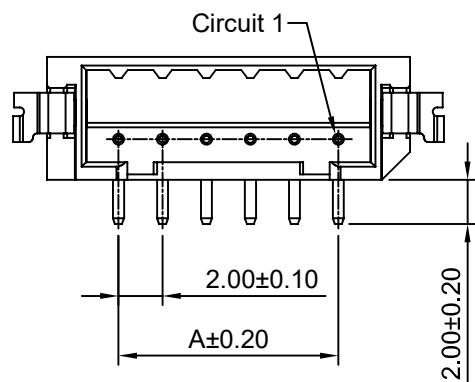


修订 REV	标记 MARK	修改摘要 REVISION DESCRIPTION	签名 SIGNATURE	日期 DATE
A0		NEW RELEASE	WANG	2013-08-20

Ordering Information:
HDGC2011WV-S-F-XP - **
1 2

- 1.Part No.
2.Finish:
(blank):Tin over Nickel
G:Gold over Nickel



Ordering Information & Dimensions

Circuits	Dimensions(mm)		Circuits	Dimensions(mm)	
	A	B		A	B
2P	2.00	8.50	9P	16.00	22.50
3P	4.00	10.50	10P	18.00	24.50
4P	6.00	12.50	11P	20.00	26.50
5P	8.00	14.50	12P	22.00	28.50
6P	10.00	16.50	13P	24.00	30.50
7P	12.00	18.50	14P	26.00	32.50
8P	14.00	20.50	15P	28.00	34.50

SPECIFICATIONS:

Current Rating: 3A AC,DC
Voltage Rating: 250V AC,DC
Temperature Range: -25°C ~ +85°C
Contact Resistance: 30mΩ Max.
Insulation Resistance: 1000MΩ Min.
Withstanding Voltage: 650V AC/minute
Pin Material: Brass/Tin over Nickel
Solder Tabs: Brass/Tin over Nickel
Material: Nylon 6T,UL94V-0(Ivory)

HDGC 深圳市华德共创科技有限公司
Shenzhen Huade co-create Technology Co.,LTD
TEL : 0755-27129737 FAX : 0755-29940187

-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表				TITLE: 产品名称: 2.00mm Pitch 180° Wafer	
X.X	±0.30	X.X°	±3°	APPD: 核准:	XIE
X.XX	±0.30	X.XX°	±2°	CHECK: 校对:	WANG
X.XXX	±0.10	X.XXX°	±1°	DRAW: 绘图:	WANG
				PART NO: 产品编号:	HDGC2011WV-S-F-XP
				DATE	SCALE
				UNIT	CODE NUMBER
				2013-08-20	3:1 mm A008